

(19) World Intellectual Property Organization  
International Bureau



(43) International Publication Date  
17 April 2003 (17.04.2003)

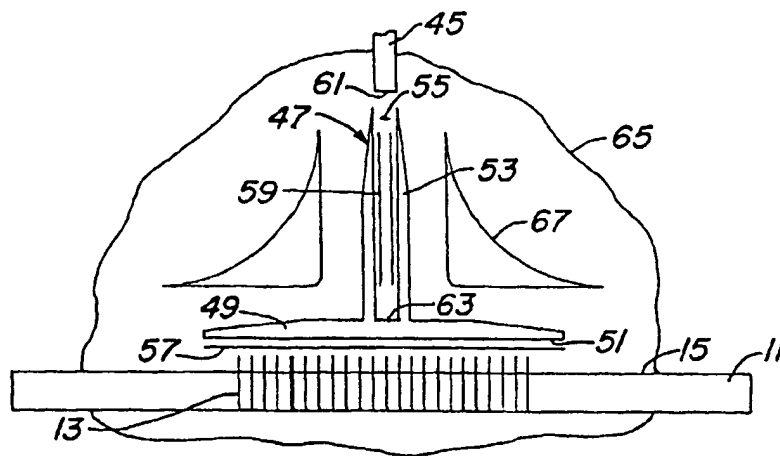
PCT

(10) International Publication Number  
WO 03/031159 A1

- (51) International Patent Classification<sup>7</sup>: B29C 65/00, B32B 7/06, B29C 70/54 (74) Agent: BRADLEY, James, E.; Bracewell & Patterson, L.L.P., P.O. Box 61389, Houston, TX 77208-1389 (US).
- (21) International Application Number: PCT/US02/19437 (81) Designated States (*national*): AE, AG, AL, AM, AT, AU, AZ, BA, BB, BG, BR, BY, BZ, CA, CH, CN, CO, CR, CU, CZ, DE, DK, DM, DZ, EC, EE, ES, FI, GB, GD, GE, GH, GM, HR, HU, ID, IL, IN, IS, JP, KE, KG, KP, KR, KZ, LC, LK, LR, LS, LT, LU, LV, MA, MD, MG, MK, MN, MW, MX, MZ, NO, NZ, OM, PH, PL, PT, RO, RU, SD, SE, SG, SI, SK, SL, TJ, TM, TN, TR, TT, TZ, UA, UG, UZ, VN, YU, ZA, ZM, ZW.
- (22) International Filing Date: 19 June 2002 (19.06.2002)
- (25) Filing Language: English
- (26) Publication Language: English
- (30) Priority Data: 09/073,208 9 October 2001 (09.10.2001) US
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- (84) Designated States (*regional*): ARIPO patent (GH, GM, KE, LS, MW, MZ, SD, SL, SZ, TZ, UG, ZM, ZW), Eurasian patent (AM, AZ, BY, KG, KZ, MD, RU, TJ, TM), European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE, TR), OAPI patent (BF, BJ, CF, CG, CI, CM, GA, GN, GQ, GW, ML, MR, NE, SN, TD, TG).
- Published:  
— with international search report

[Continued on next page]

(54) Title: CO-BONDED JOINT WITH Z-PINS



(57) Abstract: A method is provided for using a woven preform having a base and at least one leg extending from the base. The preform is used to assemble first and second composite laminate components formed from tape or fabric and a resin matrix. Z-pins are inserted into the first components prior to its being cured, forming a stubble extending above a surface of the first component. The uncured preform is placed on the surface of the first component, the stubble extending into the preform. The cured second component is attached to the preform. Over-wrap plies are optionally placed on the outer surfaces of preform. Adhesive is optionally placed between the preform and the first and second components. A vacuum bag and tooling are used while curing the preform to adhere the legs of the preform to the second component and the base of the preform to the first component.

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*For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.*

# CO-BONDED JOINT WITH Z-PINS

## BACKGROUND OF THE INVENTION

### 1. Field of the Invention

[0001] The present invention generally relates to assembly of components using woven preforms and particularly relates to assembly of components into structural joints using Z-pins and woven preforms.

### 2. Description of the Prior Art

[0002] Typical methods known in the art for attaching a composite skin to a composite frame web include forming the web as an "T" or "C" shape, making them more complex and expensive to fabricate. The flanged sections are fastened to adjacent sections using methods similar to those used with metal components, for example, by using fasteners. However, use of the fasteners adds weight to the joints.

[0003] These joints also have difficulty withstanding out-of-plane loading. Typical remedies for this are thick laminate stack-ups using many layers of composite fabric and having large flange radii. While this reduces the tension forces between the layers of the flanged section, the result is a heavy joint, reducing the weight savings realized when using composites.

[0004] Z-pins have been used to join two composite, laminate components in the prior art. For example, U.S. Pat. No. 5,968,639 to Childress discloses inserting Z-pins into a first composite component to form a stubble at a bonding face, then curing the first component. An uncured second component is then bonded to the first component with the stubble extending into and among the fibers of the second component and through the bond line.

[0005] Several techniques have been developed for inserting the Z-pins into composites laminates. Many techniques, like that described in U.S. Pat. No. 5,919,413 to Avila, are based on using a compressible foam carrier to retain the Z-pins before insertion. The pins are held in an orientation that is generally perpendicular to the surface in which they are to be inserted and are located near the surface. A piston is used to drive the pins into the surface, compressing the foam carrier as the pins are inserted. Typically, one or more nylon peel plies are placed on the surface of the laminate prior to insertion to ensure a clean bond surface and to protect the pins before assembly. The peel plies are removed prior to assembly.

## SUMMARY OF THE INVENTION

[0006] A method is provided for using a woven preform having a base and at least one leg extending from the base. The preform is used to assemble first and second composite laminate components formed from tape or fabric and a resin matrix. Z-pins are inserted into the first component prior to its being cured, forming a stubble extending above a surface of the first component. The uncured preform is placed on the surface of the first component, the stubble extending into the preform. The cured second component is attached to the preform. Over-wrap plies are optionally placed on the outer surfaces of preform. Adhesive is optionally placed between the preform and the first and second components. A vacuum bag and tooling are used while curing the preform to adhere the legs of the preform to the second component and the base of the preform to the first component.

### BRIEF DESCRIPTION OF THE DRAWINGS

[0007] The novel features believed to be characteristic of the invention are set forth in the appended claims. The invention itself however, as well as a preferred mode of use, further objects and advantages thereof, will best be understood by reference to the

1 following detailed description of an illustrative embodiment when read in conjunction  
2 with the accompanying drawings.

3 [0008] Figure 1 is a front exploded view of a method for inserting Z-pins into  
4 a first component prior to insertion of Z-pins and in accordance with the present  
5 invention.

6 [0009] Figure 2 is a front view of the component of FIG. 1 after insertion of the  
7 Z-pins and in accordance with the present invention.

8 [0010] Figure 3 is a front exploded view of a second embodiment of a method  
9 for inserting Z-pins into a first component prior to insertion of the Z-pins and in  
10 accordance with the present invention.

11 [0011] Figure 4 is a front view of the component of FIG. 3 after insertion of the  
12 Z-pins and in accordance with the present invention.

13 [0012] Figure 5 is a front exploded view of a method of joining a first and  
14 second composite components and in accordance with the present invention.

15 [0013] Figure 6 is a front view of a method of providing an oversize clevis in a  
16 preform attached to a first component and in accordance with the present  
17 invention.

## 18 19 DETAILED DESCRIPTION OF THE INVENTION

20  
21 [0014] FIGS. 1 through 5 show a method for co-bonding two composite  
22 components using a woven preform and Z-pins. FIGS. 1 through 4 detail the installation  
23 of the Z-pins in one of the components. FIG. 5 details the assembly of the components  
24 using a preform.

25 [0015] Various resin systems are sold under the terms "laminating resins" and  
26 "adhesives," though there is no "bright-line," industry-standard definition by which to  
27 distinguish one from the other. The term "adhesive" is used herein to mean a resin

1 system that has a lower modulus of elasticity and/or a higher strain-to-failure than the  
2 resin forming the matrix of the parts to be adhered. The combination of these  
3 characteristics is described as higher toughness, and adhesives have a higher toughness  
4 than laminating resins, which tend to be more brittle and have lower crack-formation  
5 loads.

6 [0016] Results from ASTM tests can be used to distinguish, generally, between  
7 laminating resins and adhesives. High-strength, structural laminating resins have a peel  
8 strength rating generally ranging from 0-15 pounds per linear inch, whereas the peel  
9 strength of adhesives is greater than 15 pounds per linear inch. For example, the Bell  
10 Peel test (ASTM D3167 "Standard Test Method for Floating Roller Peel Resistance of  
11 Adhesives") shows that the peel strength of AF191, available from 3M of St. Paul, MN,  
12 is 30-45 pounds per linear inch at room temperature, but the peel strength of 977-3,  
13 available from Cytec Industries, Inc. of West Paterson, NJ, which is used to laminate the  
14 components, is 0-6 pounds per linear inch. In addition, laminating resins generally have  
15 a tensile strength greater than 7500 pounds per square inch (psi) as tested using ASTM  
16 D638 ("Standard Test Method for Tensile Properties of Plastics"), with high-strength  
17 resins ranging to 10000 psi. Adhesives generally have tensile strengths less than 6500  
18 psi. Thus, in the present application, "adhesives" also means resin systems with tensile  
19 strengths less than 6500 psi and a peel strength greater than 15 pounds per linear inch.  
20 "Laminating resins" is used to mean resin systems having tensile strengths greater than  
21 7500 psi and a peel strength of less than 15 pounds per linear inch. Thus, when adhering  
22 two resin-infused components, an adhesive may be used between the components to  
23 provide for a high bond strength.

24 [0017] FIG. 1 shows a "green" composite panel 11 comprising a plurality of  
25 layers of uni-directional tape or woven fabric and an uncured resin matrix. The resin may  
26 be any of several available laminating resins, for example, 977-3. Panel 11 is a flat plane,  
27 but panel 11 may be curved. In order to provide for a stronger joint when adhering a

1 second composite component to panel 11, Z-pins 13 are inserted into an upper, bonding  
2 surface 15 of panel 11. Pins 13 are preferably formed from graphite or titanium and are  
3 initially held within a foam carrier 17. Pins 13 are preferably inserted as normal to  
4 surface 15, pins 13 being vertically oriented and arranged in a matrix that provides for  
5 the desired areal density and pin locations after insertion of pins 13.

6 [0018] Before insertion of pins 13, at least one peel ply 19 is placed against  
7 bonding surface 15. Peel ply 19 is infused with resin prior to application to avoid  
8 bleeding out resin from the layers of panel 11 during curing of panel 11. This first peel  
9 ply 19 ensures that bonding surface 15 remains clean until panel 11 is to be adhered to  
10 another component. Bonding surface 15 is required to be free of contaminants prior to  
11 application of adhesive, and peel ply 19 is removed just prior to use. Typically, a second,  
12 resin-infused peel ply 21 is placed over peel ply 19 to produce a desired thickness above  
13 bonding surface 15, though additional peel plies 21 can be added to increase the  
14 thickness. This thickness determines the height of the upper ends of inserted pins 13  
15 above bonding surface 15 and prevents over-insertion of pins 13. Peel plies 19, 21 are  
16 woven fabrics and are preferably formed from glass or nylon fibers, though Kevlar fibers  
17 may also be used. A non-porous, Teflon-coated film 23, such as TX 1040, available from  
18 Pall Corporation, of East Hills, NY, may be used between peel plies 19, 21 to provide for  
19 easier removal of peel ply 21 after insertion of pins 13 and curing of panel 11.

20 [0019] After application of peel plies 19, 21 and before insertion of pins 13, the  
21 entire stack of layers, comprising panel 11, plies 19, 21, and film 23, go through hot  
22 debulking. Hot debulking is a process in which the stack is brought up to a temperature  
23 that will allow the resin to flow and wet all of the fibers in panel 11, but the temperature  
24 and the time at that temperature are below those needed for curing of the resin. Though  
25 not shown, additional peel plies may be placed over peel ply 21 to produce a greater  
26 thickness above bonding surface 15. Film 23 may optionally be used between additional  
27 peel plies.

1           [0020] To insert pins 13 after the hot-debulking step, carrier 17 is located  
2 laterally on peel ply 21 to position pins 13 over the desired insertion locations. A lower  
3 surface 25 of carrier 17 containing pins 13 is placed against an upper surface 27 of peel  
4 ply 21. Pins 13 are inserted by using an ultra-sonic vibrating head (not shown) to drive  
5 them from carrier 17, through peel plies 19, 21 and film 23, and through bonding surface  
6 15 into panel 11. The vibrating head is placed against an upper surface 29 of carrier and  
7 driven downward while vibrating. Carrier is made from a foam and collapses between  
8 the head and peel ply 21 as the head moves downward. Because pins 13 are rigid, the  
9 vibrating head forces pins 13 downward once the upper ends of pins 13 come in contact  
10 with the lower surface of the head. Pins pass out of carrier 17 and through peel plies 19,  
11 21 and film 23. The lower ends of pins 13 enter panel 11 at bonding surface 15 and  
12 travel through a portion of the thickness of panel 11. Pins 13 are pushed into panel 11,  
13 preferably until the vibrating head is near upper surface 27 of peel ply 21.

14           [0021] The head is withdrawn, and carrier 17 is removed, leaving a small portion  
15 of the upper ends of pins 13 remaining above upper surface 27 of peel ply 21. If pins 13  
16 are made from graphite, the exposed ends of pins 13 are sheared off to leave the upper  
17 ends of pins 13 flush with upper surface 27, as shown in FIG. 2. If pins 13 are titanium,  
18 the vibrating head is used to drive them downward until pins 13 are flush with upper  
19 surface 27. Peel plies 21 can be removed prior to shearing or further insertion of pins 13  
20 to adjust the thickness of the stack of peel plies 19, 21 and the resulting height of pins 13,  
21 though this is typically done after adding additional peel plies 21. With pins 13 made  
22 from graphite, peel plies may be removed and the ends of pins 13 may be sheared off  
23 after panel 11 is cured.

24           [0022] Once pins are at the desired height, panel 11 is fully cured, securing pins  
25 13 in panel 11. Peel plies 19, 21 have the advantage of transferring autoclave pressures  
26 around the pins during curing, which produces a well-consolidated, distortion-free  
27 laminate panel 11. Peel plies 19, 21 remain on panel 11 and protect pins 13 during



1 curing, storage, and handling of panel 11 until peel plies 19, 21 are removed prior to  
2 assembly to expose stubble and bonding surface 15.

3 [0023] Experimentation has shown that a height of 0.030 in. of the upper ends  
4 of pins 13 over bonding surface 15 allows for less difficult removal of peel plies 19, 21  
5 and for uncured composites components to more easily "bed down," meaning they can  
6 position properly so that pins 13 enter the weave of the second component during  
7 assembly. In a situation where the component does not bed down, a resin-rich bond joint  
8 exists, weakening the assembled structure. Also, with larger heights, there is greater  
9 difficulty in pulling off peel plies 19, 21 and in causing pins 13 to properly enter the  
10 second component. However, use of larger heights, including 0.050 in. and 0.070 in.  
11 have been successfully demonstrated.

12 [0024] The preferred method uses two peel plies 19, 21, each having a thickness  
13 of approximately 0.010 in., plus film 23 to provide for the proper height of inserted pins  
14 13. Graphite can be used when creating pin stubble with a height up to 0.060 in., but  
15 exceeding this height may result in damage to the stubble when removing peel plies 19,  
16 21. For taller stubble, titanium pins should be used. The areal density of Z-pins 13  
17 having a diameter of 0.020 in. should be kept to 2% or less to provide for easier removal  
18 of peel plies 19, 21. Titanium pins also have the capability of having a bevel formed on  
19 the ends, providing easy penetration into uncured components.

20 [0025] An alternate way of ensuring the desired height of inserted pins is  
21 illustrated in FIGS. 3 and 4, this method preferably being used to create taller stubble.  
22 An uncured composite panel 31 is overlaid by a nylon peel ply 33, though peel ply 33 can  
23 be formed of other materials, as described above. Rather than using several additional  
24 peel plies to produce a thickness above bonding surface 35, an elastomeric spacer 37 is  
25 placed against peel ply 33. After hot debulking of panel 31, peel ply 33, and spacer 37,  
26 carrier 39 containing Z-pins 41 is placed against upper surface 43 of spacer 37 to position  
27 pins 41 for insertion. Pins 41 are driven through spacer 37 and peel ply 33 and into panel

1 31, as described above. After insertion, panel 31 is cured. Spacer 37 protects pins 41  
2 during curing, storage, and handling of panel 31 and is removed, along with peel ply 33,  
3 prior to assembly.

4 [0026] FIG. 5 shows the assembly of a second, cured, composite component 45  
5 to cured panel 11 using an uncured, woven, Pi-shaped preform 47. Panel 11 contains  
6 pins 13, which can be inserted using the methods shown in FIGS. 1 and 2 or in FIGS. 3  
7 and 4. Preform 47 comprises a base 49 having a continuous lower surface 51 and two  
8 upstanding legs 53 that form a clevis 55, or slot, between them. An adhesive film 57, for  
9 example, AF191, is placed between lower surface 51 of preform 47 and bonding surface  
10 15 of panel 11 for adhering preform 47 to panel 11. Preform 47 beds down onto pins 13,  
11 which enter the weave of base 49 of preform 47. Adhesive film 59 is also placed against  
12 the inner surface of legs 53 in clevis 55 for adhering legs 53 to component 45.  
13 Component 45 is then inserted into clevis 55 until lower surface 61 of component 45  
14 contacts upward-facing surface 63 of preform 47. The assembly is enclosed within a  
15 vacuum bag 65 together with silicone-rubber tooling 67 used to evenly distribute pressure  
16 along the outer surfaces of preform 47. This even distribution ensures that preform 47  
17 is pressed against surface 15 of panel 11 and that legs 53 are pressed against component  
18 45 when a vacuum is applied to bag 59.

19 [0027] An alternative method of assembly involves inserting an oversize tool 69  
20 within the clevis 55 of preform 47 and curing preform 47 with tool 69 in place of  
21 component 45 (FIG. 5), tool 69 having a width that is larger than component 45. During  
22 curing, clevis 55 takes the size and shape of tool 69. After curing, tool 69 is removed,  
23 and a paste adhesive (not shown) is injected into clevis 55. Component 45 is then  
24 inserted into oversized clevis 55 and is adhered to the preform 47 by the paste adhesive.

25 [0028] Preform 47 may also be of other shapes. FIG. 7 shows a T-shaped  
26 preform 71 has a base 73 and a single, generally-vertical leg 75 that extends from base  
27 73. As described above, pins 13 extend through base 73 and panel 11 for strengthening

1 the bond between preform 71 and panel 11. A composite component 77 is attached to  
2 leg 75 using fastener 79, though component 77 may also be attached by other means, such  
3 as by bonding. Preform 71 may also be used as a stiffener, rather than as a connector, by  
4 being bonded to a panel requiring stiffening and leg 75

5 [0029] The present invention provides for several advantages. The method of  
6 insertion of Z-pins uses peel plies to provide for control of the length of the portion of the  
7 pins that protrudes from the upper surface of the panel after the pins are driven into the  
8 panel. Also, the peel plies keep the bonding surface clean and protect the pins during  
9 storage and handling before the panel is needed for assembly. The pins are inserted into  
10 the base portion of a Pi-shaped, woven preform, providing for a joint that is stronger than  
11 without the pins.

12 [0030] While the invention has been shown in only some of its forms, it is not  
13 thus limited but is susceptible to various changes and modifications without departing  
14 from the spirit thereof.

## CLAIMS

I claim:

1. A method of making a composite structure, the method comprising:
  - (a) locating at least two peel plies on the bonding surface of a component; then
  - (b) inserting pins through the peel plies and into the component prior to curing of the component; then
  - (c) curing the component; then
  - (d) providing a woven preform having a base and two legs extending from the base, the legs defining a slot; then
  - (e) placing the base of the preform against the bonding surface of the component, the pins extending into the base of the preform; and
  - (f) curing the preform to adhere the base of the preform to the component.
2. The method of claim 1, further comprising:
  - inserting a second component into the slot of the preform after step (e) and before step (f); and

- 1            completing step (f) with the second component in the slot.  
2  
3  
4        3.     The method of claim 1, further comprising:  
5  
6            inserting a rigid sizing tool into the slot of the preform after step (e) and before  
7            step (f);  
8  
9            completing step (f) with the sizing tool in the slot;  
10  
11          removing the sizing tool after step (f), the slot being sized for insertion of a  
12          second component; and  
13  
14          inserting the second component into the slot and adhering the second component  
15          to the preform.  
16  
17  
18        4.     A method of joining first and second composite components, the method  
19            comprising:  
20  
21            (a)    inserting Z-pins into the first component prior to curing the first  
22            component, ends of the Z-pins extending above a bonding surface of the  
23            first component and forming a stubble;  
24  
25            (b)    curing the first component;

- 1 (c) providing a woven preform having a base and two legs extending from  
2 the base, the legs defining a slot;  
3
- 4 (d) placing the base of the preform against the bonding surface of the first  
5 component, the stubble extending into the base of the preform;  
6
- 7 (e) inserting the second component into the slot of the preform; and  
8
- 9 (f) curing the preform to adhere the base of the preform to the first  
10 component and the legs of the preform to the second component, joining  
11 the components with the preform.  
12  
13
- 14 5. The method of claim 4, further comprising:  
15  
16 in step (d), inserting adhesive between the base of the preform and the first  
17 component.  
18  
19
- 20 6. The method of claim 4, further comprising:  
21  
22 in step (e), inserting adhesive between the legs of the preform and the second  
23 component.  
24  
25
- 26 7. The method of claim 4, further comprising:

- 1 before step (a), locating at least two peel plies on the bonding surface of the first  
2 component and removing the peel plies after step (b) and before step (d).  
3  
4
- 5 8. The method of claim 4, further comprising:  
6  
7 before step (a), locating at least two peel plies on the bonding surface of the first  
8 component;  
9  
10 after step (b) and before step (d), removing at least one of the peel plies and  
11 trimming the stubble to a height equal to a height of the peel plies that remain on  
12 the bonding surface; and  
13  
14 removing the remaining peel plies after trimming the stubble but before step (d).  
15  
16
- 17 9. The method of claim 4, further comprising:  
18  
19 before step (a), locating at least two woven-fabric peel plies on the bonding  
20 surface of the first component and removing the peel plies after step (b) and  
21 before step (d).  
22  
23
- 24 10. The method of claim 4, wherein:  
25  
26 the peel plies are formed from nylon fibers.

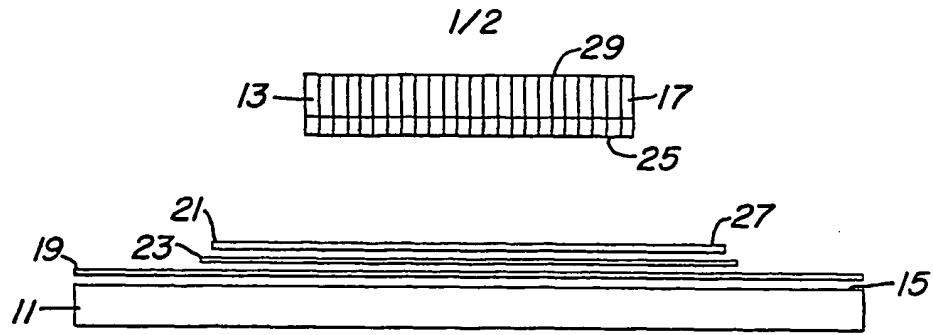
- 1        11.    The method of claim 4, wherein:  
2  
3            the peel plies are formed from glass fibers.  
4  
5  
6        12.    The method of claim 4, further comprising:  
7  
8            before step (a), locating an elastomeric spacer on the bonding surface of the first  
9            component;  
10  
11          after step (b) and before step (d), trimming the stubble to a height equal to a  
12          height of the spacer; and  
13  
14          removing the spacer after trimming the stubble but before step (d).  
15  
16  
17        13.    A method of joining first and a second composite components, the method  
18            comprising:  
19  
20            (a)    inserting Z-pins into the first component prior to curing the first  
21            component, the Z-pins extending above a bonding surface of the first  
22            component and forming a stubble; then  
23  
24            (b)    curing the first component; then  
25  
26            (c)    providing a woven preform having a base and two legs extending from  
27            the base, the legs defining a slot; then



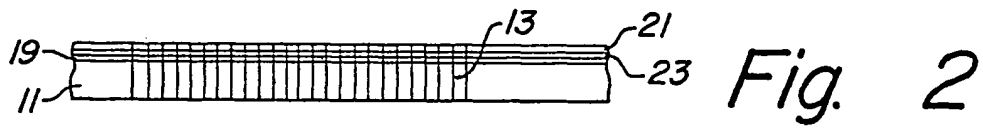
- 1 (d) placing the base of the preform against the bonding surface of the first  
2 component, the stubble extending into the base of the preform; then  
3  
4 (e) inserting a rigid sizing tool into the slot; then  
5  
6 (f) curing the preform to adhere the preform to the first component and to  
7 shape the slot to a size of the tool; then  
8  
9 (g) removing the tool and applying an adhesive into the slot; then  
10  
11 (h) inserting the second component into the slot, the adhesive bonding the  
12 second component to the preform, the second component having a smaller  
13 width than the tool.  
14  
15  
16 14. The method of claim 13, further comprising:  
17  
18 before step (a), locating at least two peel plies on the bonding surface of the first  
19 component and removing the peel plies after step (b) and before step (d).  
20  
21  
22 15. The method of claim 13, further comprising:  
23  
24 before step (a), locating at least two woven-fabric peel plies on the bonding  
25 surface of the first component and removing the peel plies after step (b) and  
26 before step (d).

- 1      16.    The method of claim 13, further comprising:  
2  
3           before step (a), locating an elastomeric spacer on the bonding surface of the first  
4           component and removing the spacer after step (b) and before step (d).  
5  
6
- 7      17.    A method of joining a preform to a panel, the method comprising:  
8  
9           (a)    inserting Z-pins into a composite panel prior to curing the panel, the Z-  
10           pins extending above a bonding surface of the panel and forming a  
11           stubble; then  
12  
13          (b)    curing the panel; then  
14  
15          (c)    providing a woven preform having a base and at least one leg that extends  
16           from the base, the preform being infused with uncured resin; then  
17  
18          (d)    placing the base of the preform against the bonding surface of the panel,  
19           the stubble extending into the base of the preform; then  
20  
21          (e)    curing the preform with each leg in a desired orientation.  
22  
23
- 24      18.    The method of claim 17, further comprising:  
25  
26          (f)    attaching a composite component to at least one leg.

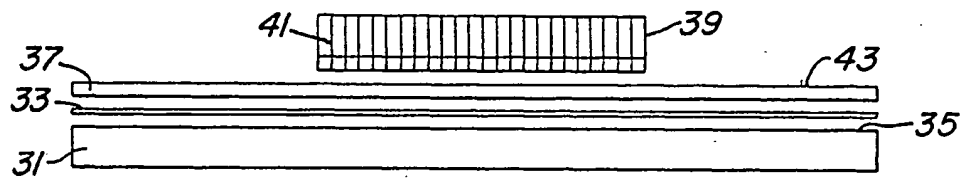
- 1      19.    The method of claim 17, further comprising:  
2  
3           before step (a), locating at least two peel plies on the bonding surface of the panel  
4           and removing the peel plies after step (b) and before step (d).  
5  
6
- 7      20.    The method of claim 17, further comprising:  
8  
9           before step (a), locating at least two woven-fabric peel plies on the bonding  
10          surface of the panel and removing the peel plies after step (b) and before step (d).  
11  
12
- 13     21.    The method of claim 17, further comprising:  
14  
15          before step (a), locating an elastomeric spacer on the bonding surface of the panel  
16          and removing the spacer after step (b) and before step (d).



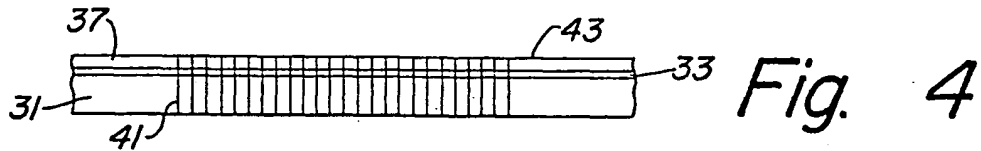
*Fig. 1*



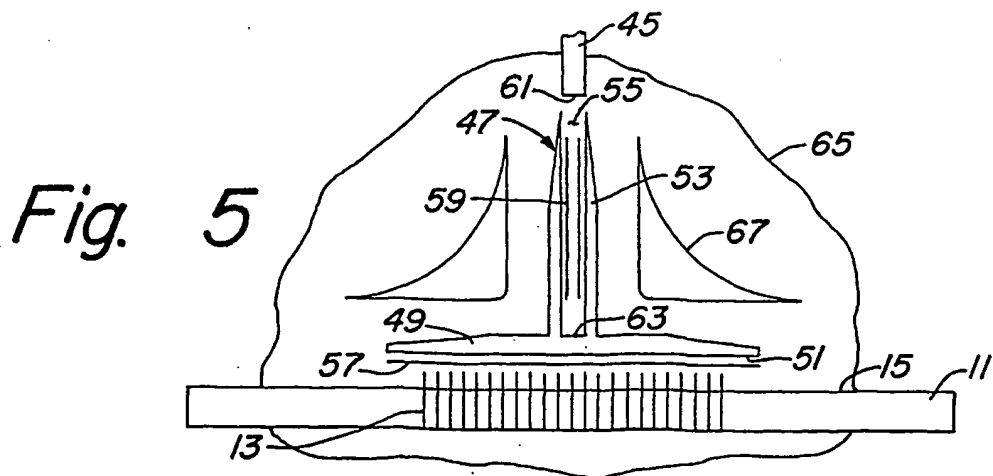
*Fig. 2*



*Fig. 3*



*Fig. 4*



*Fig. 5*

# INTERNATIONAL SEARCH REPORT

Information on patent family members

PCT/US 02/19437

| Patent document<br>cited in search report |   | Publication<br>date | Patent family<br>member(s) |           | Publication<br>date |
|---|---|---------------------|----------------------------|-----------|---------------------|
| US 5968639                                | A | 19-10-1999          | US                         | 5980665 A | 09-11-1999          |
|   |   |                     | US                         | 5863635 A | 26-01-1999          |
| US 5919413                                | A | 06-07-1999          | US                         | 5832594 A | 10-11-1998          |



## INTERNATIONAL SEARCH REPORT

PCT/US 02/19437

## A. CLASSIFICATION OF SUBJECT MATTER

IPC 7 B29C65/00 B32B7/06 B29C70/54

According to International Patent Classification (IPC) or to both national classification and IPC

## B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

IPC 7 B29C B32B

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Electronic data base consulted during the international search (name of data base and, where practical, search terms used)

## C. DOCUMENTS CONSIDERED TO BE RELEVANT

| Category * | Citation of document, with indication, where appropriate, of the relevant passages                                   | Relevant to claim No. |
|------------|--|-----------------------|
| A          | US 5 968 639 A (CHILDRESS JAMES J)<br>19 October 1999 (1999-10-19)<br>cited in the application<br>the whole document | 1-21                  |
| A          | US 5 919 413 A (AVILA STEVEN J)<br>6 July 1999 (1999-07-06)<br>cited in the application<br>the whole document        | 1-20                  |



Further documents are listed in the continuation of box C.



Patent family members are listed in annex.

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Date of the actual completion of the international search

25 September 2002

Date of mailing of the international search report

07/10/2002

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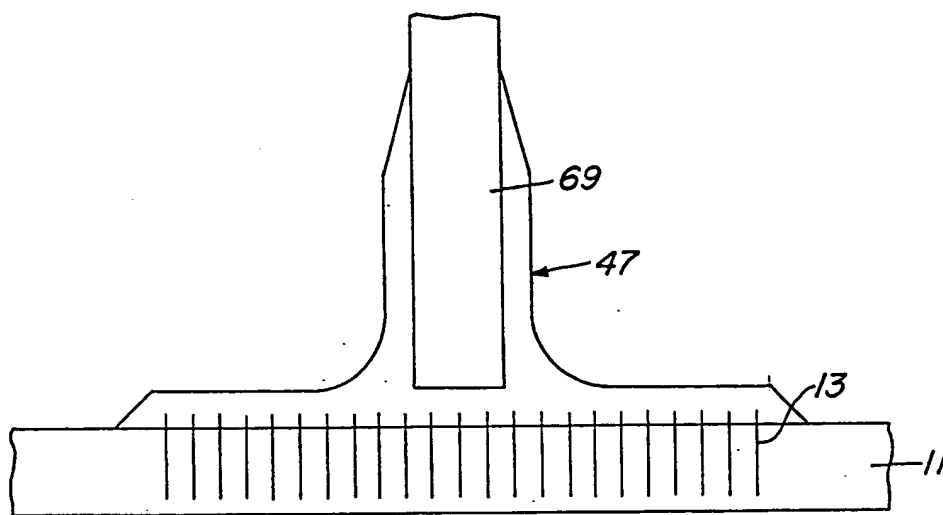


Fig. 6

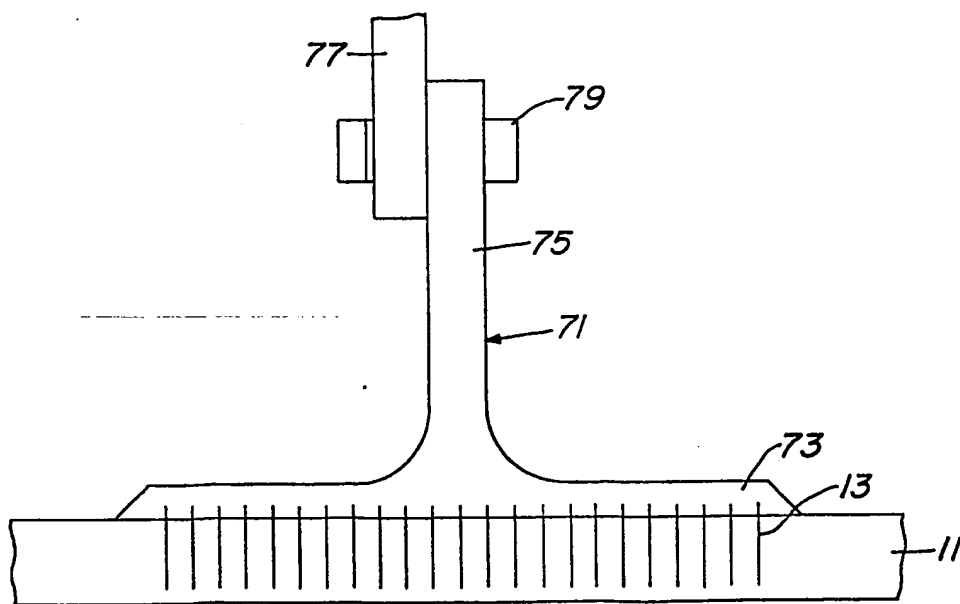


Fig. 7